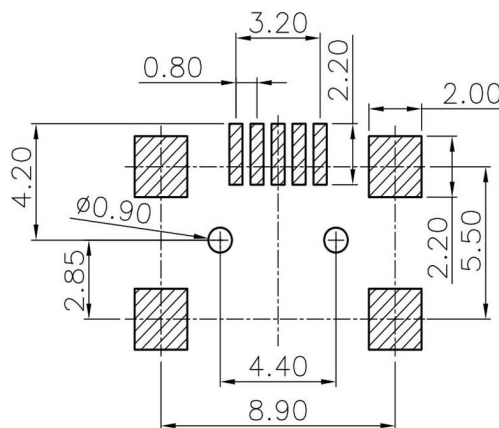
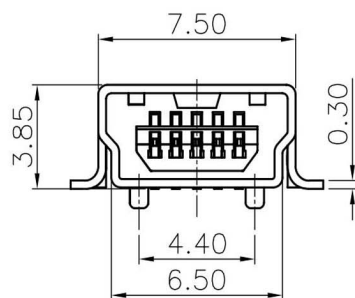
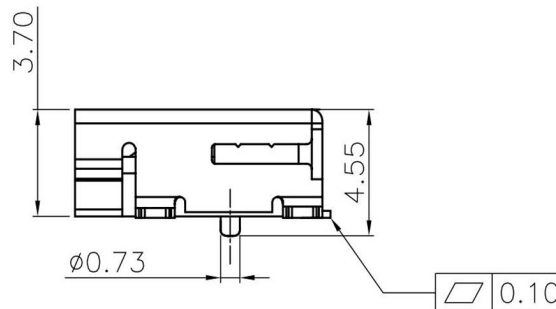
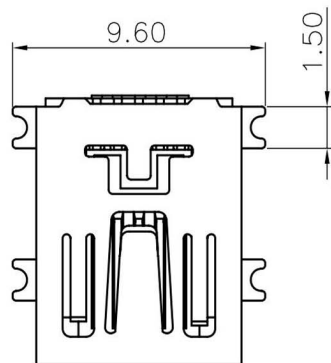
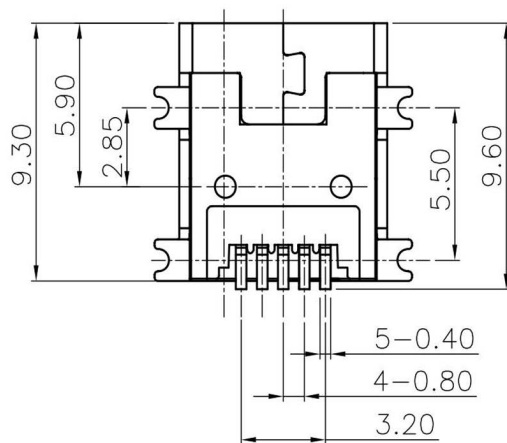




PCB LAYOUT



Specifications:

Electrical:

1. Contact Resistance: 50 milliohms MAX
2. Insulation Resistance: 100MEGA ohms MIN
3. Dielectric Withstanding Voltage: 100 V AC AT Sea Level

Material:

1. Housing: Hing Temperature Tnermaplastics, UI 94V-0 LCP Black
2. Contact: Copper Alloy C5191
3. Shell: Copper Alloy C2680

Finish:

1. Contact: Plated Gold in Mating Area; Tin On Solder Talls
2. Shell: Nickel Plating

RoHS Compliant		HSM 玄茂科技股份有限公司	
		HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例	TOLERANCE 容許公差	PART NAME 品名
DWG. 製圖	參考	.0 ± 0.30 .00 ± 0.20 ANG. ± 3°	MINI USB1.1 5P FEMALE B TYPE SMT TYPE
DATE 制表日	UNIT 單位	SIZE 紙張尺寸	P.C.B. SMT TYPE PLASTIC POLARIZING PES 4.4mm
2014/08/06	PAGE 張數	REV. 版次	MYLAR+REEL PACKING BLACK INSULATOR ROHS
	1 OF 2	B	PART NO.
			料號 C8320-05BFDXX1R

